

Notice of References Cited	Application/Control No. 10/600,596	Applicant(s)/Patent Under Reexamination SHIBATA ET AL.	
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<input type="checkbox"/>		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
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